

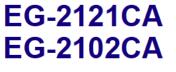
Crystal oscillator

SEIKO EPSON CORPORATION

LOW-JITTER SAW OSCILLATOR (SPSO) OUTPUT : LV-PECL, LVDS, HCSL



Product Number EG-2121CA: Q3805CAx0xxxx00 : X1M000101xxxx00 EG-2102CA: Q3806CA00xxxx00 : X1M000091xxxx00



 Frequency range Supply voltage
 Supply voltage

•External dimensions :

Function

53.125 MHz to 700 MHz 2.5 V ... EG-2121CA 3.3 V ... EG-2102CA LV-PECL or LVDS or HCSL Output enable (OE) 7.0 × 5.0 × 1.2 mm

•Very low jitter and low phase noise by SAW unit.

Specifications (characteristics)

Differential LV-PECL Output		EG-2121CA	EG-2102CA		
Item	Symbol			Conditions / Remarks	
		LV-PECL			
Output frequency range	fo	53.125 MHz to 500 MHz	100 MHz to 700 MHz	Please contact us about available frequencies.	
Supply voltage	Vcc	2.5 V ± 0.125 V	3.3 V ± 0.3 V		
Storage temperature	T_stg	-40 C to	+100 C	Storage as single product.	
Operating temperature	T_use	P:0 C to +70 C, R: -5 C to	0 +85 C, S: -20 C to +70 C		
Frequency tolerance	f_tol	G: ± 50 × 10 ⁻⁶ ,	H: ±100 × 10 ⁻⁶		
Current consumption	lcc	80 mA Max.	100 mA Max.	OE=Vcc, L ECL=50 Ω	
Disable current	l_dis	20 mA Max.	32 mA Max	OE=GND	
Symmetry	SYM	P:40 % to 60 % (fo > 350 MHz) P:45 % to 55 % (fo ≤ 350 MHz)	P:45 % to 55 %	at outputs crossing point	
		D:48 % to 52 % (fo ≤ 175 MHz)	D:48 % to 52 % (fo ≤ 350 MHz)		
Outer the set	Voн	1.55 V Typ. Vcc-1.025 V	2.35 V Typ. to V _{CC} -0.88 V	DC characteristics	
Output voltage	Vol	0.8 V Typ. Vcc-1.81 V t	<u>1.6 V Typ.</u> o V _{cc} -1.62 V		
Output load condition (ECL)	L ECL	50 Ω		Terminated to V _{cc} -2.0 V	
Input voltage		70 % V _{CC} Min. 30 % V _{CC} Max.		OE terminal	
Rise time / Fall time	tr / tf			Between 20 % and 80 % of	(VOH-VOL)
Start-up time	t str	10 ms Max.		Time at minimum supply vo	
Phase Jitter	_	0.8 ps Max.		fo < 100 MHz	
	t _{PJ}	0.5 ps Max.		100 MHz \leq fo < 200 MHz 20 MHz	Offset frequency: 12 kHz to 20 MHz
		0.3 ps Max.		200 MHz ≤ fo	
Frequency aging	f aging	± 10 × 10 ⁻⁶	/ year Max.	+25 C, First year, Vcc=2.5	V. 3.3 V

►LVDS Output

Hom	Cumbal	EG-2121CA	EG-2102CA	Condition	
Item	Symbol	LVDS		Conditions / Remarks	
Output frequency range	fo	53.125 MHz to 700 MHz		Please contact us about available frequencies.	
Supply voltage	Vcc	2.5 V ± 0.125 V 3.3 V ± 0.3 V			
Storage temperature	T_stg	-40 C to	+100 C	Storage as single product.	
Operating temperature	T_use	P:0 C to +70 C, R: -5 C to	+85 C, S: -20 C to +70 C		
Frequency tolerance	f_tol	G: ± 50 × 10 ⁻⁶ ,	H: ±100 × 10 ⁻⁶		
Current consumption	lcc	30 mA Max	45 mA Max.	OE=V _{cc} , L LVDS= 100 Ω	
Disable current	l_dis	20 mA Max	30 mA Max.	OE=GND	
Symmetry	SYM	L:40 % to 60 % (fo > 350 MHz) L:45 % to 55 % (fo \leq 350 MHz) V:48 % to 52 % (fo \leq 175 MHz)	L:40 % to 60 % (fo > 350 MH2) L:45 % to 55 % (fo ≤ 350 MH2) V:48 % to 52 % (fo ≤ 175 MH2)	at outputs crossing point	
	Vod	350 mV Typ. 24	7 mV to 454 mV	VOD1, VOD2	
Output voltage	dVop	50 mV Max.		dVop = Vop1-Vop2	DC characteristics
	Vos	1.25 V Typ. 1.125 V to 1.375 V		Vos1, Vos2	
	dVos	150 mV Max.		dVos = Vos1-Vos2	
Output load condition (LVDS)	L_LVDS	100 Ω		Connected between OUT to	े ठण
Input voltage	VIH	70 % V _{cc} Min.		OE terminal	
Input voltage	VIL	30 % V _{cc} Max.			
Rise time / Fall time	tr / tr			Peak voltage	f Differential Output Peak to
Start-up time	t_str			Time at minimum supply vo	Itage to be 0 s
Phase Jitter	teu	0.8 ps Max.		fo < 100 MHz	Offset frequency: 12 kHz to
		0.5 ps Max.		100 MHz ≤ fo < 200 MHz	-20 MHz
		0.3 ps Max.		200 MHz ≤ fo	
Frequency aging	f_aging	\pm 10 × 10 ⁻⁶ / year Max.		+25 C, First year, Vcc=2.5	V, 3.3 V

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HCSL Output

Item	Symbol	EG-2121CA	EG-2102CA	Conditions	/ Domarka
nem		HCSL		Conditions / Remarks	
Output frequency range	fo	100 MHz to 350 MHz P		Please contact us about available frequencies.	
Supply voltage	Vcc	2.5 V ± 0.125 V	3.3 V ± 0.3 V		
Storage temperature	T_stg	-40 C to	+125 C	Storage as single product.	
Operating temperature	T_use	P:0 C to +70 C, R: -5 C to	+85 C, S: -20 C to +70 C		
Frequency tolerance	f_tol	G: ± 50 × 10 ⁻⁶ ,	H: ±100 × 10 ⁻⁶		
Current consumption	lcc	80 mA Max.	85 mA Max.	OE=Vcc, L HCSL=50 Ω	
Disable current	l_dis	20 mA Max.	35 mA Max	OE=GND	
Symmetry	SYM	45 % to 55 %		at outputs crossing point	
Output Voltage	V _{OH}	0.75 \		DC characteristics	
	VoL	-0.3 V Typ.			
Output load condition (HCSL)	L HCSL	50 Ω		Terminated to GND	
Input voltage	VIH	70 % Vcc Min.		OE terminal	
	VIL	30 % V _{CC} Max.			
Rise time / Fall time	tr / tr	500 ps Max.		Between 0.175 V and 0.525	V of output
Start-up time	t str	10 ms Max.		Time at minimum supply vol	tage to be 0 s
		0.8 ps Max.		fo < 100 MHz	Offset frequency: 12 kHz to
Phase Jitter	teu	0.5 ps Max.		100 MHz \leq fo $<$ 200 MHz	20 MHz
		0.3 ps Max.		200 MHz ≤ fo	
Frequency aging *2	f_aging	± 10 × 10 ⁻⁶ / year Max.		+25 C, First year, Vcc=2.5	V, 3.3 V

Product Name

EG-2121 CA 250.000000MHz P G P A

(Standard form)

1 2 3 4567

OModel
 @Package type
 ③Frequency

(4) Output/Symmetry (5) Frequency tolerance (6) Operating temperature

⑦ Frequency aging (A*1: Frequency tolerance include aging, N*2: Frequency tolerance exclude aging)

*1 This includes initial frequency tolerance, temperature variation, supply voltage change, reflow drift, and aging(+25 C,10 years).
 *2 This includes initial frequency tolerance, temperature variation, supply voltage change, and reflow drift(except aging).
 (5)607: GRA, GSA are not available)

(5)6: As for LV-PECL and LVDS output, for 53.125 MHz \leq fo < 100 MHz only HP is available)

		•	-		
4	Output	Symmetry		5 Frequency tolerance	
Symbol	Output	EG-2121CA	EG-2102CA	G	±50 × 10 ⁻⁶
Р	LV-PECL	40 % to 60 %(fo > 350 MHz) 45 % to 55 %(fo ≤ 350 MHz)	45 % to 55 %	H	±100 × 10 ⁻⁸
D	LV-PECL	48 % to 52 %(fo≤ 175 MHz)		perating temperature 0 °C to +70 °C	
L	LVDS	40 % to 60 %(fo > 350 MHz) 45 % to 55 %(fo ≤ 350 MHz)			-5 °C to +85 °C -20 °C to +70 °C
V	LVDS	48 % to 52 %(fo ≤ 175 MHz)			
Н	HCSL	45 % to 55 %			

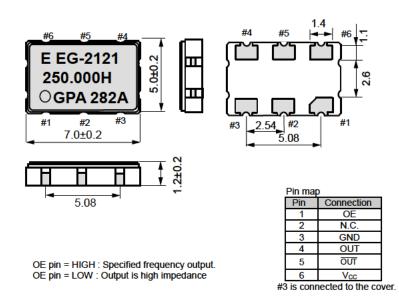
Table 2 Jitter

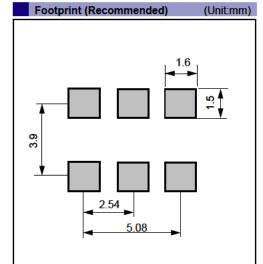
Item	Symbol	Specifications	Remarks
	toj	0.2 ps Typ.	Deterministic Jitter
	t _{RJ}	3 ps Typ.	Random Jitter
Jitter *	t _{RMS}	3 ps Typ.	σ (RMS of total distribution)
	t _{p-p}	25 ps Typ.	Peak to Peak
	t _{acc}	4 ps Typ.	Accumulated Jitter(σ) n=2 to 50 000 cycles

(Unit:mm)

* Tested using a DTS-2075 Digital iming system made by WAVECREST with jitter analysis software VISI6. : Differential LV-PECL, LVDS output * Based on SIA-3100C signal integrity analyzer made from WAVECREST. : HCSL output

External dimensions





To maintain stable opera ion, provide a 0.01 uF to 0.1 uF by-pass capacitor at a location as near as possible to the power source terminal of the crystal product (between Vcc - GND).

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major automotive manufacturers as standard.

Explanation of the mark that are using it for the catalog

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IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

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